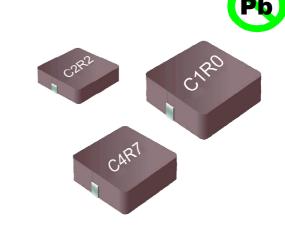


SMD Molding Power Inductor

Features

- 1. Magnetically shielded construction, low DC resistance;
- 2. The use of magnetic iron powder ensure capability for large current;
- 3. Low audible core noise;
- 4. Ideal for DC-DC converter applications in hand held personal computer and etc;
- 5、Frequency Range: up to 3.0MHz;
- 6、RoHS compliant。



Applications

- 1、Smart phone、MID;
- 2. Next-generation mobile devices with multifunction such as adding color TV and digital movie cameras;
- 3、Flat-screen TVs, blue-ray disc recorders, set top box;
- 4. Notebooks, desktop computers, servers, graphic cards;
- 5. Portable gaming devices, personal navigation systems, personal multimedia devices;
- 6. Automotive systems;
- 7、Telecomm base stations。

◆ Lead Free Part Numbering

CMLO 1350 H 100 M T T (1) (2) (3) (4) (5) (6) (7)

(1) Series Type

(2) Dimension: AXC

(3) Material Code

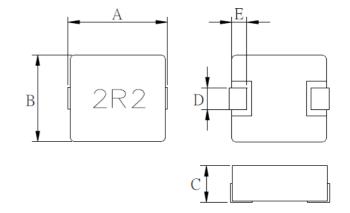
(4) Inductance: 2R2=2.2μH;

100=10µH; 101=100µH

(5) Inductance Tolerance: M=±20%, Y=±30%

(6) Company Code

(7) Packaging: packed in embossed carrier tape



♦ Dimensions

Series	A±0.3 (mm)	B ±0.3 (mm)	C (mm)	D±0.3 (mm)	E±0.3 (mm)
CMLO1350H	13.6 Max	12.6 Max	5.0 Max	3.5	2.5

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♦ Specification

Part Number	INDUCTAN CE Lo(μ H)	Rdc (mΩ) Max	Test a condition	SATURATION CURRENT(Isat) DC AMPS2	HEAT RATING CURRENT(Idc) DC AMPS1
CMLO1350H Series	()	Max		(Typ.)	(Typ.)
CMLO1350HR22MTT	0.22	0.7	100KHz/1V	75	50
CMLO1350HR36MTT	0.36	0.85	100KHz/1V	50	42
CMLO1350HR50MTT	0.50	1.15	100KHz/1V	48	38
CMLO1350HR68MTT	0.68	1.55	100KHz/1V	46	33
CMLO1350HR82MTT	0.82	1.67	100KHz/1V	39	30
CMLO1350H1R0MTT	1.0	2.2	100KHz/1V	35	26
CMLO1350H1R5MTT	1.5	3.2	100KHz/1V	33	23
CMLO1350H2R2MTT	2.2	5.0	100KHz/1V	24	15
CMLO1350H3R3MTT	3.3	7.0	100KHz/1V	22	14
CMLO1350H4R7MTT	4.7	9.0	100KHz/1V	20	13
CMLO1350H6R8MTT	6.8	18	100KHz/1V	16	12
CMLO1350H8R2MTT	8.2	20	100KHz/1V	13	9.5
CMLO1350H100MTT	10	22	100KHz/1V	12	9.0
CMLO1350H150MTT	15	30	100KHz/1V	10	8.0
CMLO1350H220MTT	22	58	100KHz/1V	6.5	4.5
CMLO1350H330MTT	33	84	100KHz/1V	6.0	3.5
CMLO1350H470MTT	47	130	100KHz/1V	5.0	3.0

NOTES:

- 1. DC current (Idc) that will cause an approximate △T of 40°C
- 2. DC current (Isat) that will cause Lo to drop approximately 20%
- 4. Operating Temperature Range -55°C to +150°C
- 5. The part temperature (ambient + temp rise) should not exceed 150° C under the worst operating conditions. Circuit design, component placement, PWB trace size and thickness, airflow and other cooling provisions all affect

the part temperature. Part temperature should be verified in the end application.

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◆ Reliability Test

Item	Specification and Requirement	Test Method			
	1. No case deformation or change in	1.Preheat: 155℃±5℃, 60S±2S			
Solderability	apperarance	2.Tin: lead-free.			
	2. New solder coverage More than 90%	3.Temperature:245℃±5℃, flux 3.0S±0.5S.			
	1. No case deformation or change in	1. Acceleration: 100G			
Mechanical	apperarance	2. Pulse time:: 6ms			
shock	2. △L/Lo≦±10%	3. 3 times in each positive and negative direction of 3 mutual perpendicular directions			
	1. No case deformation or change in	1. The test samples shall be soldered to the board.			
	apperarance	Then it shall be submitted to below test conditions.			
	2. △L/Lo≦±10%	Fre. Range 10~55Hz			
Mechanical		Total Amplitude 1.5mm			
vibration		Sweeping Method 10Hz to 55Hz to 10Hz			
Vibration		Time For 2 hours on each X,Y,Z axis.			
		Recovery: At least 2 hours of recovery under the			
		standard condition after the test, followed by the			
		measurement within 24 ±2 hours.			
	Inductance change:	1. First -55℃ for 30 minutes,last 125℃ for 30			
	Within ± 10% Without distinct damage	minutes as 1 cycle. Go through 1000 cycles.			
Thermal Shock	in appearance	2. Max transfer time is 2 minutes.			
		3. Measured at room temperature after placing for			
		24±2 hours			
	Inductance change:	1.Reflow 2 times,			
Humidity	Within ± 10% Without distinct damage	2.85℃,85%RH,1000 hours			
Resistance	in appearance	3.Measured at room temperature after placing for			
		24±2 hours			
Low	Inductance change:	1. Temperature: -55 ± 2°C 2. Time: 1000 hours			
temperature	Within ± 10% Without distinct damage				
storage	in appearance	3. Measured at room temperature after placing for			
5.5.ag6		24±2 hours			

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High temperature storage	Inductance change: Within ± 10% Without distinct damage in appearance	 Temperature: +125 ± 2^o Time: 1000 hours Measured at room temperature after placing for 24±2 hours
Board Flex	Inductance change: Within ± 10% Without distinct damage in appearance	 Run through IR reflow for 2 times; Place the 100mm X 40mm board into a fixture similar to the one shown in below Figure with the component facing down The apparatus shall consist of mechanical means to apply a force which will bend the board (D) x = 2 mm minimum. The duration of the applied forces shall be 60±5 sec. The force is to be applied only once to the oard.
Terminal Strength	No removal or split of the termination or other defects shall occur.	 The test samples shall be soldered to the board Push the product vertically from the side of the sample using the thrust tester. Automotive electronics: 17.7N, 60S±1s, X, Ydirect. X direct

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♦ Recommended Soldering Technologies

(1) Re-flowing Profile

Preheat condition: 150 ~200 °C/60~180sec.

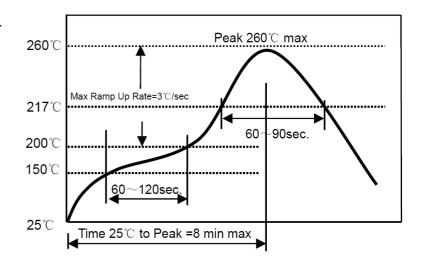
Allowed time above 217°C: 80~120sec.

Max temp: 260°C

Max time at max temp: 10 sec.

Solder paste: Sn/3.0Ag/0.5Cu

Allowed Reflow time: 2x max



(2) Iron Soldering Profile

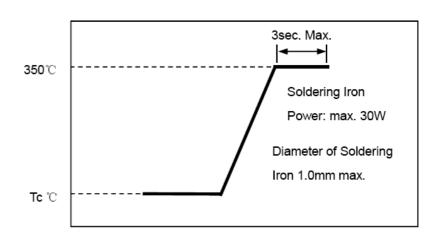
Iron soldering power: Max. 30W

Pre-heating: 150 °C/60sec.

Soldering time: 3sec. Max.

Solder paste: Sn/3.0Ag/0.5Cu

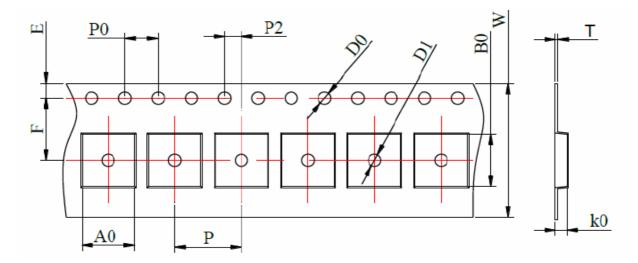
Max.1 times for iron soldering





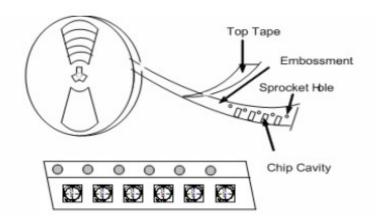
◆ Packaging Information

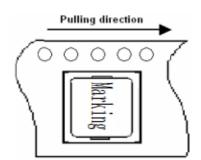
(1) Tape Packaging Dimensions (Unit: mm)



Type	Tape dimensions (mm)											
Туре	W	Р	P0	P2	D0	D1	Т	A0	В0	K0	Е	F
CMLO1350	24 ±0.3	16 ±0.1	4.0 ±0.1	2.0 ±0.1	1.5 ±0.1	1.5 ±0.1	0.5 ±0.05	13.1 ±0.1	14 ±0.1	5.4 ±0.1	1.75 ±0.1	11.5 ±0.1

Taping Drawings (UNIT:mm)

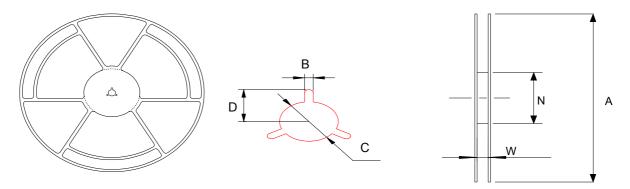




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(2) Reel Dimensions (Unit: mm)



А	W	N	В	С	D
330+2.0	24±0.5	97±0.5	2.2+0.5	13.0±0.2	10.75±0.25

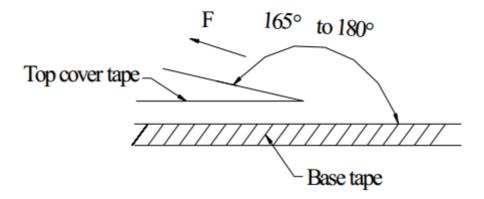
(3) Packaging Quantity(PCS)

Туре	Standard Quantity				
	Reel	Inner box	Carton box		
CMLO1350	500 pcs / reel	2Reel / box (1000 pcs)	4 Middle boxes, (4000 pcs)		

(4) Peel force of top cover tape

The peel speed shall be about 300mm/minute

The peel force of top cover tape shall be between 0.1 to 1.3 N



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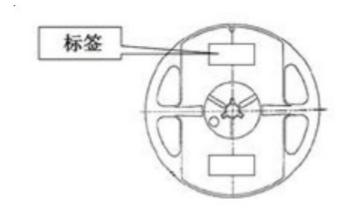
(5) Reel Label

Label on the reel

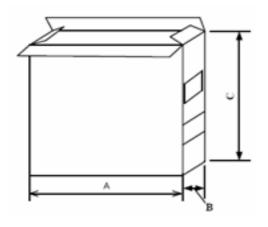
- · Customer's part Number
- Lot Number
- Quantity
- date code

Shipping Label

- · Customer's part Number
- · Manufacturer's part Number
- Quantity
- · date code

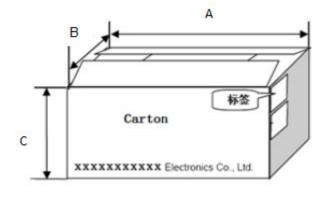


(6) Inner Box



Packaging type A(mm)		B (mm)	C (nun.)	
lnner box	335	70	340	

(7) Carton



Packaging type	A (mm)	B (mm)	C (mm)
type	360	360	360